

DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

☐ Original ☐ Supplemental ☐ Substitute ☒ PCT ☐ DESIGN

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Title: SUBSTRATE PLATING METHOD AND APPARATUS

of which is described and claimed in:

☐ the attached specification, or

☐ the specification in application Serial No. _____, filed February 9, 2001, and with amendments through _____, or

☒ the specification in International Application No. PCT/JP99/04349, filed August 11, 1999, and as amended on (if applicable).

I hereby state that I have reviewed and understand the content of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

I acknowledge my duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I hereby claim priority benefits under Title 35, United States Code, §119 (and §172 if this application is for a Design) of any application(s) for patent or inventor's certificate listed below and have also identified below any application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:


COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED
Japanese	10-239490	August 11, 1998	YES
Japanese	11-30230	February 8, 1999	YES
Japanese	11-220363	August 3, 1999	YES

I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

APPLICATION SERIAL NO.	U.S. FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

And I hereby appoint Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Warren M. Cheek, Jr., Reg. No. 33,367; Nils Pedersen, Reg. No. 33,145; Charles R. Watts, Reg. No. 33,142; and Michael S. Huppert, Reg. No. 40,268, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., as well as any other attorneys and agents associated with Customer No. 000513, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith.

I hereby authorize the U.S. attorneys and agents named herein to accept and follow instructions from WATANABE & HOTTA as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

Direct Correspondence to Customer No:  000513 PATENT TRADEMARK OFFICE	Direct Telephone Calls to: WENDEROTH, LIND & PONACK, L.L.P. 2033 "K" Street, N.W., Suite 800 Washington, D.C. 20006 Phone: (202) 721-8200 Fax: (202) 721-8250
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Full Name of First Inventor	FAMILY NAME HONGO	FIRST GIVEN NAME Akihisa	SECOND GIVEN NAME
Residence & Citizenship	CITY Tokyo	STATE OR COUNTRY JAPAN	COUNTRY OF CITIZENSHIP JAPAN
Post Office Address	ADDRESS c/o Ebara Corporation, 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo 144-8510 Japan	CITY	STATE OR COUNTRY ZIP CODE
Full Name of Second Inventor	FAMILY NAME OGURE	FIRST GIVEN NAME Naoaki	SECOND GIVEN NAME
Residence & Citizenship	CITY Tokyo	STATE OR COUNTRY JAPAN	COUNTRY OF CITIZENSHIP JAPAN
Post Office Address	ADDRESS c/o Ebara Corporation, 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo 144-8510 Japan	CITY	STATE OR COUNTRY ZIP CODE
Full Name of Third Inventor	FAMILY NAME INOUE	FIRST GIVEN NAME Hiroaki	SECOND GIVEN NAME
Residence & Citizenship	CITY Tokyo	STATE OR COUNTRY JAPAN	COUNTRY OF CITIZENSHIP JAPAN
Post Office Address	ADDRESS c/o Ebara Corporation, 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo 144-8510 Japan	CITY	STATE OR COUNTRY ZIP CODE
Full Name of Fourth Inventor	FAMILY NAME SENDAI	FIRST GIVEN NAME Satoshi	SECOND GIVEN NAME
Residence & Citizenship	CITY Tokyo	STATE OR COUNTRY JAPAN	COUNTRY OF CITIZENSHIP JAPAN
Post Office Address	ADDRESS c/o Ebara Corporation, 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo 144-8510 Japan	CITY	STATE OR COUNTRY ZIP CODE
Full Name of Fifth Inventor	FAMILY NAME IKEGAMI	FIRST GIVEN NAME Tetsuma	SECOND GIVEN NAME
Residence & Citizenship	CITY Tokyo	STATE OR COUNTRY JAPAN	COUNTRY OF CITIZENSHIP JAPAN
Post Office Address	ADDRESS c/o Ebara Corporation, 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo 144-8510 Japan	CITY	STATE OR COUNTRY ZIP CODE

Full Name of Sixth Inventor	FAMILY NAME MISHIMA	FIRST GIVEN NAME Koji	SECOND GIVEN NAME
Residence & Citizenship	CITY Tokyo	STATE OR COUNTRY JAPAN	COUNTRY OF CITIZENSHIP JAPAN
Post Office Address	ADDRESS c/o Ebara Corporation, 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo 144-8510 Japan		
Full Name of Seventh Inventor	FAMILY NAME OKUYAMA	FIRST GIVEN NAME Shuichi	SECOND GIVEN NAME
Residence & Citizenship	CITY Tokyo	STATE OR COUNTRY JAPAN	COUNTRY OF CITIZENSHIP JAPAN
Post Office Address	ADDRESS c/o Ebara Corporation, 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo 144-8510 Japan		
Full Name of Eighth Inventor	FAMILY NAME NAGAI	FIRST GIVEN NAME Mizuki	SECOND GIVEN NAME
Residence & Citizenship	CITY Tokyo	STATE OR COUNTRY JAPAN	COUNTRY OF CITIZENSHIP JAPAN
Post Office Address	ADDRESS c/o Ebara Corporation, 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo 144-8510 Japan		
Full Name of Ninth Inventor	FAMILY NAME KIMIZUKA	FIRST GIVEN NAME Ryoichi	SECOND GIVEN NAME
Residence & Citizenship	CITY Tokyo	STATE OR COUNTRY JAPAN	COUNTRY OF CITIZENSHIP JAPAN
Post Office Address	ADDRESS 15-6, Matsubara 5-chome, Setagaya-ku, Tokyo 156-0043 Japan		
Full Name of Tenth Inventor	FAMILY NAME MARUYAMA	FIRST GIVEN NAME Megumi	SECOND GIVEN NAME
Residence & Citizenship	CITY Yokohama-shi	STATE OR COUNTRY JAPAN	COUNTRY OF CITIZENSHIP JAPAN
Post Office Address	ADDRESS GARDENIA PARK #603, 1-43, Nagatsuda 7-chome, Midori-ku, Yokohama-shi, Kanagawa 226-0027 Japan		

I further declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

1st Inventor _____ Date _____
Akihisa HONGO

2nd Inventor _____ Date _____
Naoaki OGURE

3rd Inventor _____ Date _____
Hiroaki INOUE

4th Inventor _____ Date _____
Satoshi SENDAI

5th Inventor _____ Date _____
Tetsuma IKEGAMI

6th Inventor _____ Date _____
Koji MISHIMA

7th Inventor _____ Date _____
Shuichi OKUYAMA

8th Inventor _____ Date _____
Mizuki NAGAI

9th Inventor _____ Date _____
Ryoichi KIMIZUKA

10th Inventor _____ Date _____
Megumi MARUYAMA

The above application may be more particularly identified as follows:

U.S. Application Serial No. NEW Filing Date February 9, 2001

Applicant Reference Number GEB1400-US (PFB185) Atty Docket No. 2001_0133A

Title of Invention SUBSTRATE PLATING METHOD AND APPARATUS